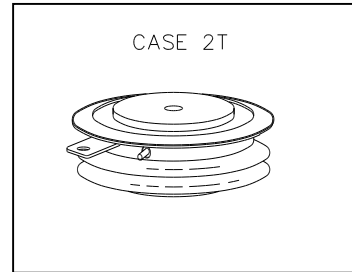


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**HIGH POWER THYRISTOR FOR PHASE CONTROL APPLICATIONS**

**Features:**

- . All Diffused Structure
- . Center Amplifying Gate Configuration
- . Blocking capability up to 2000 volts
- . Guaranteed Maximum Turn-Off Time
- . High dV/dt Capability
- . Pressure Assembled Device



**ELECTRICAL CHARACTERISTICS AND RATINGS**

**Blocking - Off State**

Device Type	V <sub>RRM</sub> (1)	V <sub>DRM</sub> (1)	V <sub>RSM</sub> (1)
N282CH10	1000	1000	1100
N282CH12	1200	1200	1300
N282CH14	1400	1400	1500
N282CH16	1600	1600	1700
N282CH18	1800	1800	1900
N282CH20	2000	2000	2000

V<sub>RRM</sub> = Repetitive peak reverse voltage  
 V<sub>DRM</sub> = Repetitive peak off state voltage  
 V<sub>RSM</sub> = Non repetitive peak reverse voltage (2)

Notes:

All ratings are specified for T<sub>j</sub>=25 °C unless otherwise stated.

- (1) All voltage ratings are specified for an applied 50Hz/60zHz sinusoidal waveform over the temperature range -40 to +125 °C.
- (2) 10 msec. max. pulse width
- (3) Maximum value for T<sub>j</sub> = 125 °C.
- (4) Minimum value for linear and exponential waveshape to 80% rated V<sub>DRM</sub>. Gate open. T<sub>j</sub> = 125 °C.
- (5) Non-repetitive value.
- (6) The value of di/dt is established in accordance with EIA/NIMA Standard RS-397, Section 5-2-2-6. The value defined would be in addition to that obtained from a snubber circuit, comprising a 0.2 μF capacitor and 20 ohms resistance in parallel with the thristor under test.

Repetitive peak reverse leakage and off state leakage	I <sub>RRM</sub> / I <sub>DRM</sub>	15 mA 30 mA (3)
Critical rate of voltage rise (4)	dV/dt	200 V/μsec

**Conducting - on state**

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	I <sub>T(AV)</sub>		600		A	Sinewave, 180° conduction, T <sub>c</sub> = 55°C
RMS value of on-state current	I <sub>TRMS</sub>		1202		A	Nominal value
Peak one cycle surge (non repetitive) current	I <sub>TSM</sub>		7500		A	10.0 msec (50Hz), sinusoidal wave-shape, 180° conduction, T <sub>j</sub> = 125 °C
I square t	I <sup>2</sup> t		305000		A <sup>2</sup> s	10.0 msec
Latching current	I <sub>L</sub>		800		mA	V <sub>D</sub> = 24 V; R <sub>L</sub> = 12 ohms
Holding current	I <sub>H</sub>		400		mA	V <sub>D</sub> = 24 V; I = 2.5 A
Peak on-state voltage	V <sub>TM</sub>		2.35		V	I <sub>TM</sub> = 1550 A; Duty cycle ≤ 0.01%
Critical rate of rise of on-state current (5, 6)	di/dt		400		A/μs	Switching from V <sub>DRM</sub> ≤ 1000 V, non-repetitive
Critical rate of rise of on-state current (6)	di/dt		150		A/μs	Switching from V <sub>DRM</sub> ≤ 1000 V

## Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	$P_{GM}$		200		W	$t_p = 40 \mu s$
Average gate power dissipation	$P_{G(AV)}$		5		W	
Peak gate current	$I_{GM}$		10		A	
Gate current required to trigger all units	$I_{GT}$		150		mA	$V_D = 6 V; R_L = 3 \text{ ohms}; T_j = +25^\circ C$
Gate voltage required to trigger all units	$V_{GT}$		3		V	$V_D = 6 V; R_L = 3 \text{ ohms}; T_j = 25^\circ C$
Peak negative voltage	$V_{GRM}$		5		V	

## Dynamic

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	$t_d$		1.5	0.7	$\mu s$	$I_{TM} = 50 A; V_D = \text{Rated } V_{DRM}$ Gate pulse: $V_G = 20 V; R_G = 20 \text{ ohms};$ $t_r = 0.1 \mu s; t_p = 20 \mu s$
Turn-off time (with $V_R = -50 V$ )	$t_q$		200	125	$\mu s$	$I_{TM} = 500 A; di/dt = 25 A/\mu s;$ $V_R \geq -50 V; \text{Re-applied } dV/dt = 20$ $V/\mu s \text{ linear to } 80\% V_{DRM}; V_G = 0;$ $T_j = 125^\circ C; \text{Duty cycle } \geq 0.01\%$
Reverse recovery charge	$Q_{rr}$		*		$\mu C$	$I_{TM} = 500 A; di/dt = 25 A/\mu s;$ $V_R \geq -50 V$

\* For guaranteed max. value, contact factory.

## THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	$T_j$	-40	+125		$^\circ C$	
Storage temperature	$T_{stg}$	-40	+150		$^\circ C$	
Thermal resistance - junction to case	$R_{\theta(j-c)}$	0.045 (1)	0.055 (2)		$^\circ C/W$	Double sided cooled * (1) @ 2000 lb.; (2) @ 800 lb.
Thermal resistance - junction to case	$R_{\theta(j-c)}$	0.090 (1)	0.110 (2)		$^\circ C/W$	Single sided cooled * (1) @ 2000 lb.; (2) @ 800 lb.
Thermal resistance - case to sink	$R_{\theta(c-s)}$		.030 .060		$^\circ C/W$	Double sided cooled * Single sided cooled *
Mounting force	P	800 3.6	2500 11.1		lb. kN	
Weight	W			2.5 70	oz. g	

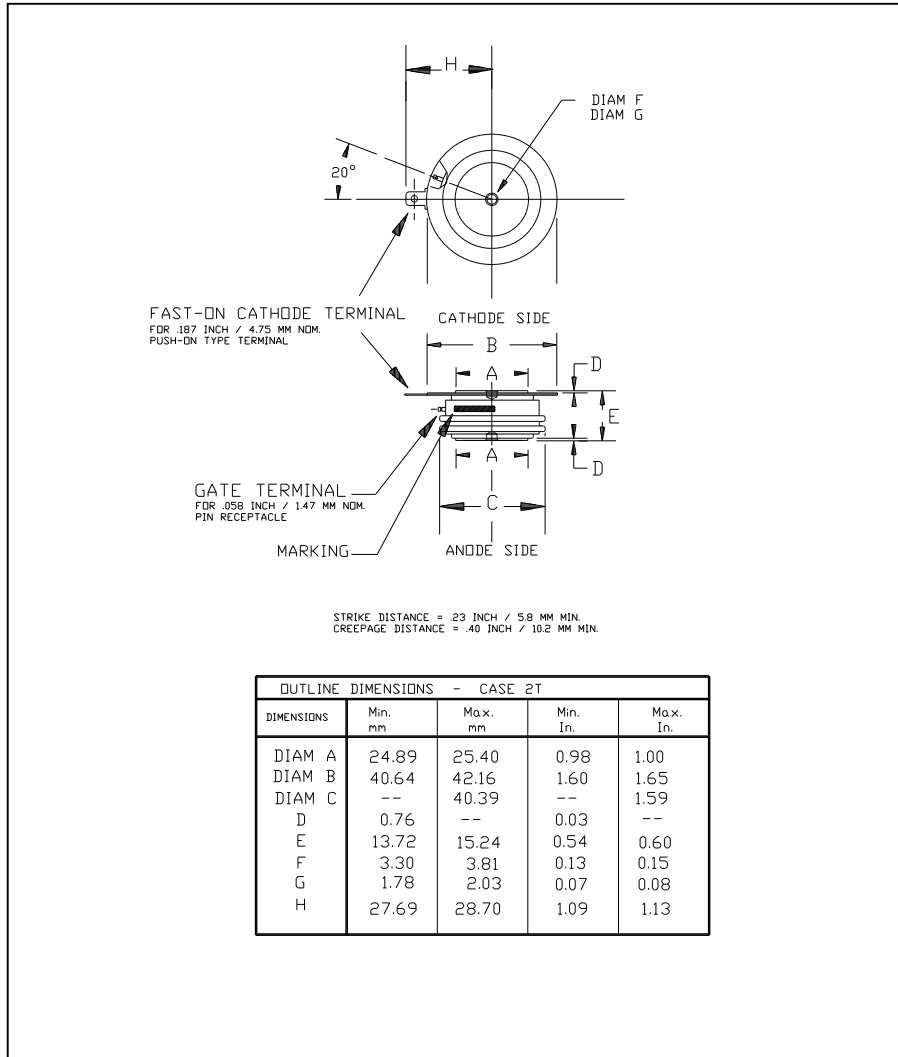
\* Mounting surfaces smooth, flat and greased

Note : for case outline and dimensions, see case outline drawing in page 4 of this Technical Data

**N282CH - POWER THYRISTOR**

CASE OUTLINE AND DIMENSIONS.

N282CH- Power Thyristor



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